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Team Nexperia

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

Rev. 3 — 20 December 2011

Product data sheet

1. Product profile

1.1 General description

NPN/NPN Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

| Type number | | | | | Package |
|-------------|--------|-------|------------|------------|---------------------------|
| | NXP | JEITA | complement | complement | configuration |
| PEMH10 | SOT666 | - | PEMD10 | PEMB10 | ultra small and flat lead |
| PUMH10 | SOT363 | SC-88 | PUMD10 | PUMB10 | very small |

1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

1.4 Quick reference data

Table 2. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---------------------------|------------|------|------|------|------|
| Per transis | stor | | | | | |
| V _{CEO} | collector-emitter voltage | open base | - | - | 50 | V |
| lo | output current | | - | - | 100 | mA |
| R1 | bias resistor 1 (input) | | 1.54 | 2.20 | 2.86 | kΩ |
| R2/R1 | bias resistor ratio | | 17 | 21 | 26 | |



2 3 sym063

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

2. Pinning information

| Table 3. | Pinning | | |
|----------|------------------------|--------------------|----------------|
| Pin | Description | Simplified outline | Graphic symbol |
| 1 | GND (emitter) TR1 | | |
| 2 | input (base) TR1 | | |
| 3 | output (collector) TR2 | | |
| 4 | GND (emitter) TR2 | | |
| 5 | input (base) TR2 | | |
| 6 | output (collector) TR1 | 001aab555 | |

3. Ordering information

| Table 4. Ordering information | | | | | | |
|---------------------------------------|---------|--|---------|--|--|--|
| Type number | Package | | | | | |
| | Name | Description | Version | | | |
| PEMH10 | - | plastic surface-mounted package; 6 leads | SOT666 | | | |
| PUMH10 | SC-88 | plastic surface-mounted package; 6 leads | SOT363 | | | |

4. Marking

| Table 5. Marking codes | |
|------------------------|-----------------------------|
| Type number | Marking code ^[1] |
| PEMH10 | 10 |
| PUMH10 | H*0 |

[1] * = placeholder for manufacturing site code.

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

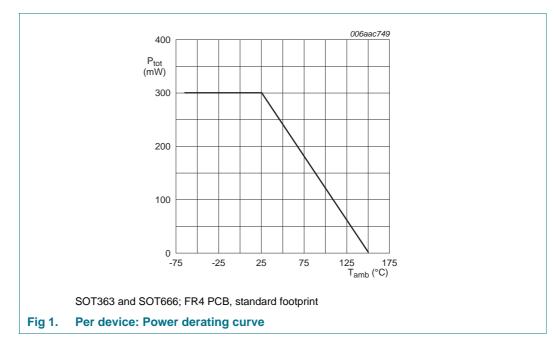
5. Limiting values

| Symbol | Parameter | Conditions | Min | Мах | Unit |
|------------------|---------------------------|-------------------------------|------------|------|------|
| Per transis | stor | | | | |
| V _{CBO} | collector-base voltage | open emitter | - | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 50 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 5 | V |
| VI | input voltage | | | | |
| | positive | | - | +12 | V |
| | negative | | - | -5 | V |
| lo | output current | | - | 100 | mA |
| I _{CM} | peak collector current | | - | 100 | mA |
| P _{tot} | total power dissipation | $T_{amb} \leq 25 \ ^{\circ}C$ | <u>[1]</u> | | |
| | PEMH10 (SOT666) | | [2] _ | 200 | mW |
| | PUMH10 (SOT363) | | - | 200 | mW |
| Per device |) | | | | |
| P _{tot} | total power dissipation | $T_{amb} \leq 25 ~^{\circ}C$ | [1] | | |
| | PEMH10 (SOT666) | | [2] _ | 300 | mW |
| | PUMH10 (SOT363) | | - | 300 | mW |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω



6. Thermal characteristics

| Table 7. | Thermal characteristic | S | | | | |
|----------------------|---|-------------|------------|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Per trans | sistor | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | [1] | | | |
| | PEMH10 (SOT666) | | [2] | - | 625 | K/W |
| | PUMH10 (SOT363) | | - | - | 625 | K/W |
| Per devi | се | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | <u>[1]</u> | | | |
| | PEMH10 (SOT666) | | [2] _ | - | 417 | K/W |
| | PUMH10 (SOT363) | | - | - | 417 | K/W |

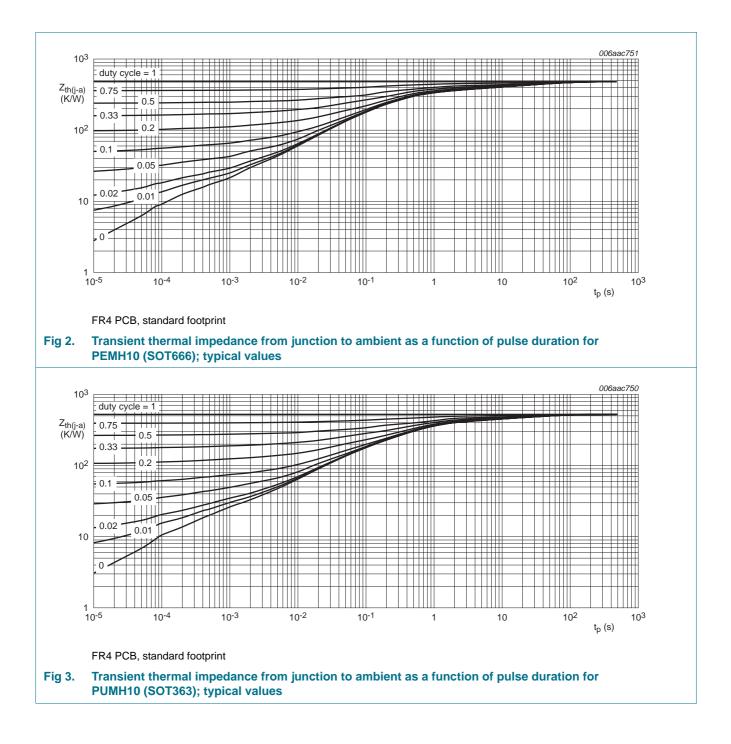
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

PEMH10_PUMH10

PEMH10; PUMH10

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω



NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

7. Characteristics

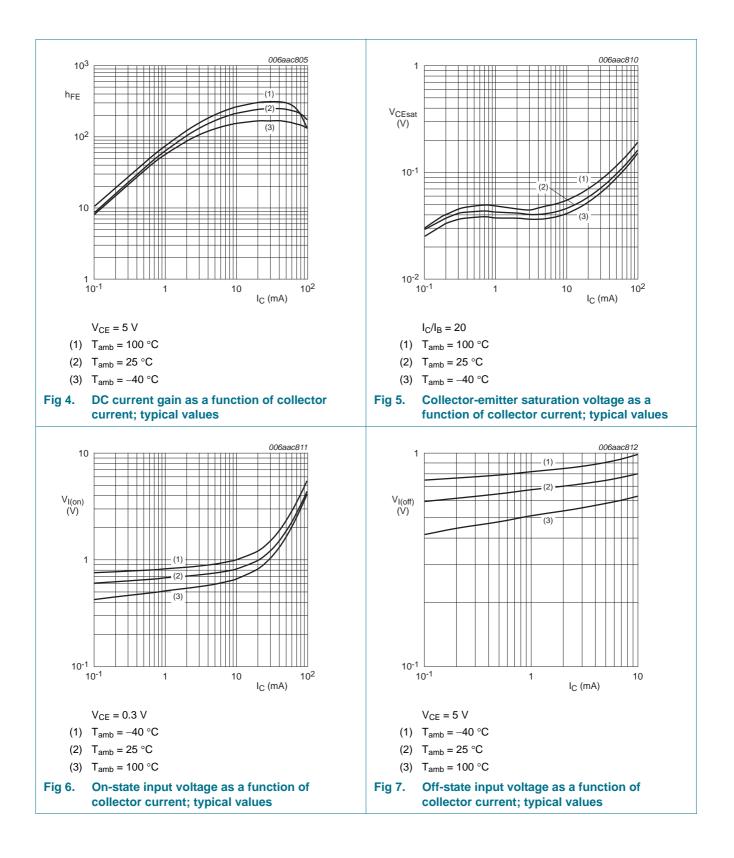
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------|---|---|------------|------|------|------|------|
| Per trans | istor | | | | | | |
| I _{CBO} | collector-base cut-off current | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$ | | - | - | 100 | nA |
| I _{CEO} | collector-emitter | $V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}$ | | - | - | 100 | nA |
| | cut-off current | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$ | | - | - | 5 | μA |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 V; I_C = 0 A$ | | - | - | 180 | μA |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA}$ | | 100 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_{C} = 5 \text{ mA}; I_{B} = 0.25 \text{ mA}$ | | - | - | 100 | mV |
| V _{I(off)} | off-state input voltage | $V_{CE} = 5 \text{ V}; \text{ I}_{C} = 100 \mu\text{A}$ | | - | 0.6 | 0.5 | V |
| V _{I(on)} | on-state input voltage | $V_{CE} = 0.3 \text{ V}; \text{ I}_{C} = 5 \text{ mA}$ | | 1.1 | 0.75 | - | V |
| R1 | bias resistor 1 (input) | | | 1.54 | 2.20 | 2.86 | kΩ |
| R2/R1 | bias resistor ratio | | | 17 | 21 | 26 | |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz | | - | - | 2.5 | рF |
| f _T | transition frequency | V _{CB} = 5 V; I _C = 10 mA; f = 100 MHz | <u>[1]</u> | - | 230 | - | MHz |

[1] Characteristics of built-in transistor.

PEMH10_PUMH10 Product data sheet

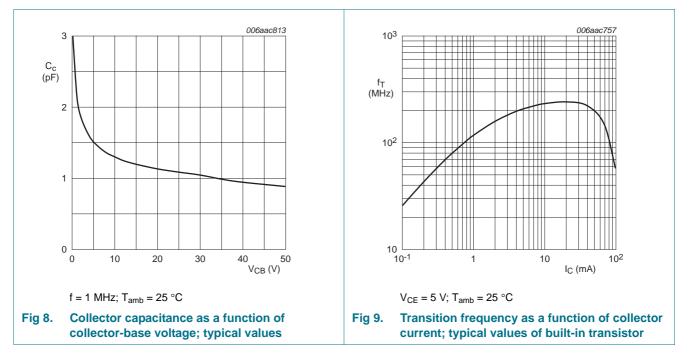
PEMH10; PUMH10

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω



PEMH10; PUMH10

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω



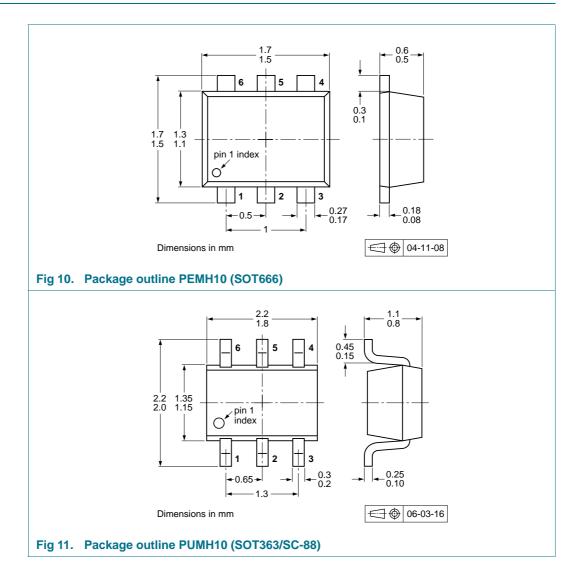
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

9. Package outline



NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

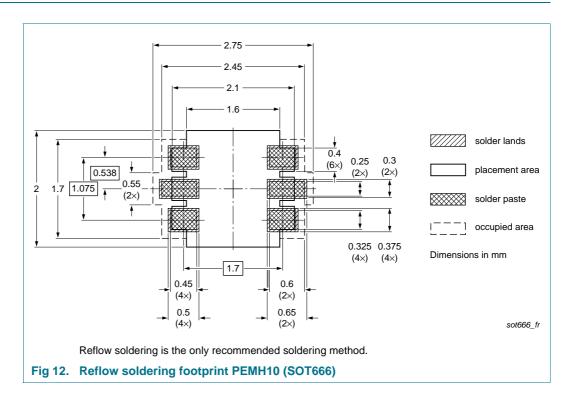
| Type number Package | | Description | | Packing quantity | | | |
|---------------------|--------|------------------------------------|-----|------------------|------|------|-------|
| | | | 3 | 000 | 4000 | 8000 | 10000 |
| PEMH10 | SOT666 | 2 mm pitch, 8 mm tape and reel | - | | - | -315 | - |
| | | 4 mm pitch, 8 mm tape and reel | - | | -115 | - | - |
| PUMH10 | SOT363 | 4 mm pitch, 8 mm tape and reel; T1 | [2] | 115 | - | - | -135 |
| | | 4 mm pitch, 8 mm tape and reel; T2 | [3] | 125 | - | - | -165 |

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

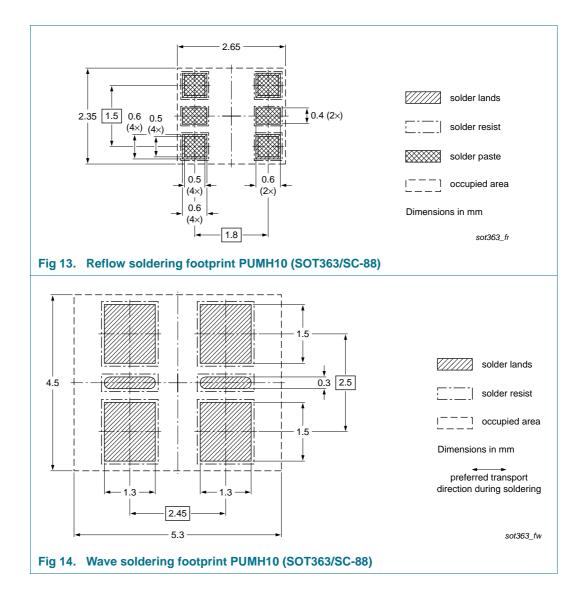
[2] T1: normal taping

[3] T2: reverse taping

11. Soldering



NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω



NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|--------------------|---|---|---------------|--------------------------|--|--|
| PEMH10_ PUMH10 v.3 | 20111220 | Product data sheet | - | PEMH10_ PUMH10 v.2 | | |
| Modifications: | The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. | | | | | |
| | Legal texts have been adapted to the new company name where appropriate. | | | | | |
| | Section 1 "Product profile": updated | | | | | |
| | <u>Section 4 "Marking"</u> : updated | | | | | |
| | <u>Table 7 "Thermal characteristics"</u>: updated according to the latest measurements | | | | | |
| | | $\frac{\text{racteristics}}{\text{recteristics}}: I_{CEO} \text{ updated}$ ed to $V_{I(off)} \text{ off-state input vertex}$ | | | | |
| | Figure 1 to 9: added | | | | | |
| | <u>Section 8 "Test information"</u>: added | | | | | |
| | Figure 10 and 11: replaced by minimized package outline drawings | | | | | |
| | <u>Section 10 "Packing information"</u>: added | | | | | |
| | <u>Section 11 "Soldering"</u> : added | | | | | |
| | <u>Section 13 "Legal information"</u>: updated | | | | | |
| PEMH10_PUMH10 v.2 | 20031020 | Product data sheet | - | PEMH10 v.1 PUMH10 v.1 | | |
| PEMH10 v.1 | 20011022 | Preliminary specification | on - | - | | |
| PUMH10 v.1 | 20000801 | Product specification | | - | | |

PEMH10_PUMH10 **Product data sheet** NPN/NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 47k Ω

13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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[1] Please consult the most recently issued document before initiating or completing a design.

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NPN/NPN resistor-equipped transistors; $R1 = 2.2 \text{ k}\Omega$, $R2 = 47 \text{k}\Omega$

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